



P-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)		
- 20	0.027 at $V_{GS} = -4.5 \text{ V}$	- 8.2		
	0.032 at V _{GS} = - 2.5 V	- 7.5		
	0.045 at V _{GS} = - 1.8 V	- 6.6		

FEATURES

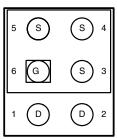
- Halogen-free according to IEC 61249-2-21 **Definition**
- TrenchFET® Power MOSFET
- MICRO FOOT® Chipscale Packaging Reduces Ultra-Low Footprint Area Profile (0.62 mm) and On-Resistance

• Compliant to RoHS Directive 2002/95/EC



MICRO FOOT

Bump Side View



Backside View

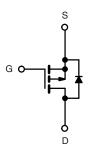
Device Marking: 8407

xxx = Date/Lot Traceability Code

Ordering Information: Si8407DB-T2-E1 (Lead (Pb)-free and Halogen-free)

APPLICATIONS

- · Portable Devices
 - PA Switch
 - Battery Switch
 - Load Switch



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)					
Parameter	Symbol	5 s	Steady State	Unit	
Drain-Source Voltage		V_{DS}	- 20		٧
Gate-Source Voltage		V _{GS}	± 8		V
Continuous Drain Current /T 150 °C\8	T _A = 25 °C	I _D	- 8.2	- 5.8	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		- 6.5	- 4.6	
Pulsed Drain Current		I _{DM}	- 15		Α
Continuous Source Current (Diode Conduction) ^a		I _S	- 2.6	- 1.34	
Mariana Bana Biariantina	T _A = 25 °C	P _D	2.9	1.47	W
Maximum Power Dissipation ^a	T _A = 70 °C		1.86	0.94	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C
Package Reflow Conditions ^b	IR/Convection		2	60	C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum burstian to Ambienta	t ≤ 5 s	R _{thJA}	33	43	°C/W
Maximum Junction-to-Ambient ^a	Steady State		72	85	
Maximum Junction-to-Foot (drain)	Steady State	R _{thJF}	15	19	

- a. Surface mounted on 1" x 1" FR4 board.
- b. Refer to IPC/JEDEC (J-STD-020), no manual or hand soldering.

Document Number: 72254 S11-1383-Rev. D, 11-Jul-11

Vishay Siliconix



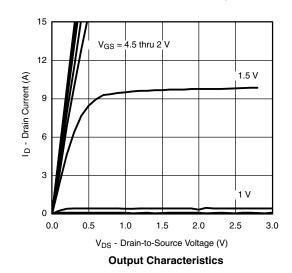
Parameter	Symbol	Symbol Test Conditions		Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -350 \mu A$	- 0.4		- 0.9	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zara Cata Valtaga Drain Current		V _{DS} = - 20 V, V _{GS} = 0 V	- 1		4		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 20 V, V _{GS} = 0 V, T _J = 70 °C			- 5	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 5			Α	
		V _{GS} = - 4.5 V, I _D = - 1 A		0.022	0.027		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 2.5 V, I _D = - 1 A		0.026	0.032	Ω	
		V _{GS} = - 1.8 V, I _D = - 1 A		0.033	0.045		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 1 A	I A			S	
Diode Forward Voltage ^a	V_{SD}	I _S = - 1 A, V _{GS} = 0		- 0.6	- 1.1	V	
Dynamic ^b							
Total Gate Charge	Q_g			32	50		
Gate-Source Charge	Q_{gs}	V_{DS} = - 10 V, V_{GS} = - 4.5 V, I_D = - 1 A		3.6		nC	
Gate-Drain Charge	Q_{gd}			8.5		1	
Turn-On Delay Time	t _{d(on)}			30	45		
Rise Time	t _r	V_{DD} = - 10 V, R_L = 10 Ω		45	70		
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ - 1 A, $V_{GEN}=$ - 4.5 V, $R_g=6~\Omega$		550	825	ns	
Fall Time	t _f			220	330		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 1 A, dI/dt = 100 A/μs		265	500		

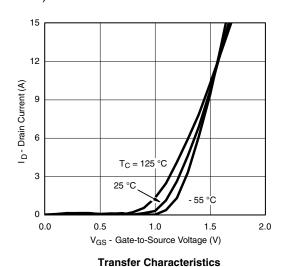
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

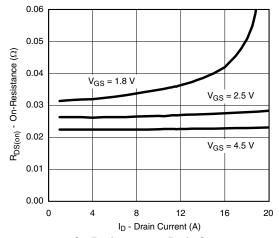




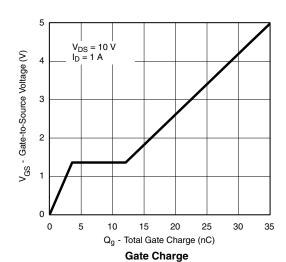


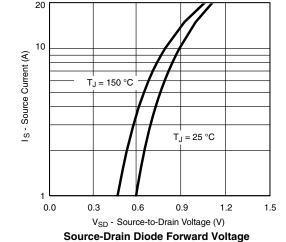


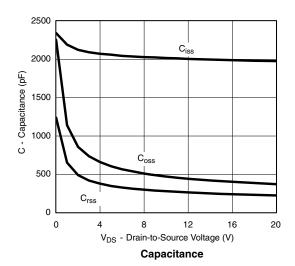
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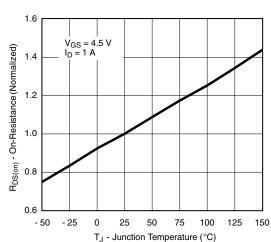


On-Resistance vs. Drain Current

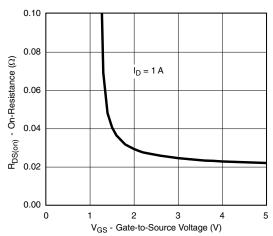








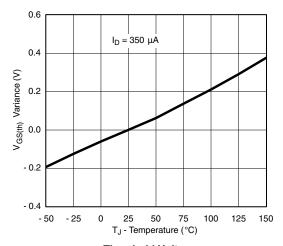
On-Resistance vs. Junction Temperature

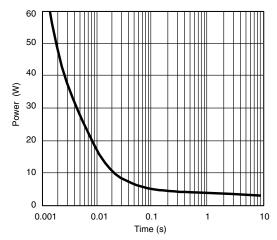


On-Resistance vs. Gate-to-Source Voltage

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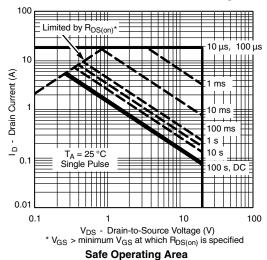
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

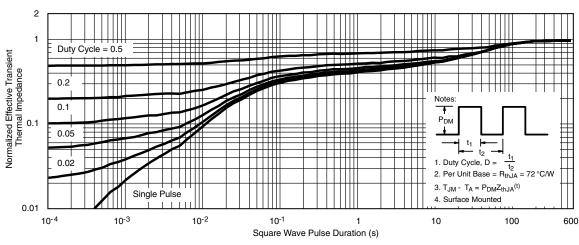




Threshold Voltage

Single Pulse Power, Junction-to-Ambient

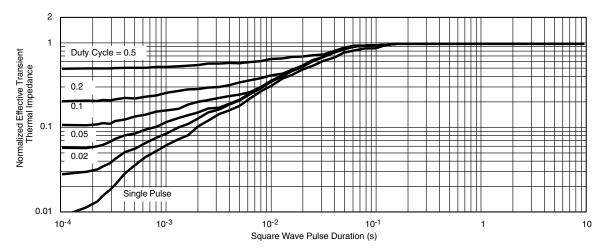




Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

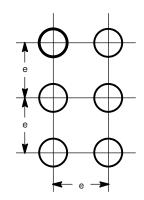


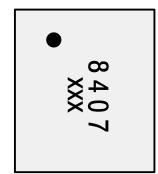
Normalized Thermal Transient Impedance, Junction-to-Foot

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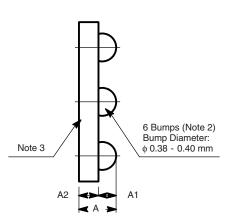
PACKAGE OUTLINE

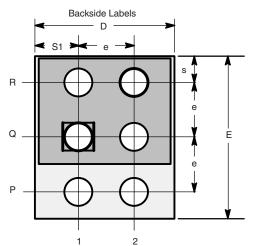
MICRO FOOT: 6-BUMP (2.4 mm x 2 mm, 0.8 mm PITCH)





Recommended Land





Notes (Unless Otherwise Specified):

- 1. All dimensions are in millimeters.
- 2. Bumps are 95.5/3.8/0.7 Sn/Ag/Cu with diameter φ 0.38 mm 0.40 mm.
- 3. Backside surface is coated with a Ti/NI/Ag layer.
- 4. Non-solder mask defined copper landing pad.
- 5. The flat side of wafers is oriented at the bottom.
- 6. is location of Pin 1P.

Dim.	Millim	eters ^a	Inches		
	Min.	Max.	Min.	Max.	
Α	0.600	0.650	0.0236	0.0256	
A ₁	0.260	0.290	0.0102	0.0114	
A ₂	0.340	0.360	0.0134	0.0142	
b	0.370	0.410	0.0146	0.0161	
D	1.920	2.000	0.0756	0.0787	
E	2.320	2.400	0.0913	0.0945	
е	0.750	0.850	0.0295	0.0335	
S	0.370	0.400	0.0150	0.0157	
S1	0.580	0.600	0.0228	0.0236	

PAD DISTRIBUTION TABLE					
	Р	Q	R		
1	Drain	Gate	Source		
2	Drain	Source	Source		

Notes:

a. Use millimeters as the primary measurement.

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